

#### Is Now Part of



### ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="guestions@onsemi.com">guestions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



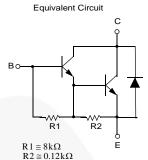
March 2016

## MJD122 NPN Silicon Darlington Transistor

#### **Features**

- D-PAK for Surface Mount Applications
- · High DC Current Gain
- Built-in a Damper Diode at E-C
- Lead Formed for Surface Mount Applications
- Electrically Similar to Popular TIP122
- Complement to MJD127





#### **Ordering Information**

Part Number	Top Mark	Package	Packing Method
MJD122TF	MJD122	TO-252 3L (DPAK)	Tape and Reel

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	100	V
$V_{CEO}$	Collector-Emitter Voltage	100	V
$V_{EBO}$	Emitter-Base Voltage	5	V
I <sub>C</sub>	Collector Current (DC)	8	А
I <sub>CP</sub>	Collector Current (Pulse)	16	Α
I <sub>B</sub>	Base Current	120	mA
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> = 25°C)	20	W
	Collector Dissipation (T <sub>A</sub> = 25°C)	1.75	W
TJ	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 65 to 150	°C

#### **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Test Condition	Min.	Max.	Units
V <sub>CEO</sub> (sus)	Collector-Emitter Sustaining Voltage <sup>(1)</sup>	$I_C = 30 \text{ mA}, I_B = 0$	100		V
I <sub>CEO</sub>	Collector Cut-off Current	$V_{CE} = 50 \text{ V}, I_{B} = 0$		10	μΑ
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = 100 \text{ V}, I_{E} = 0$		10	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 5 \text{ V}, I_{C} = 0$		2	mA
h <sub>FE</sub>	DC Current Gain <sup>(1)</sup>	V <sub>CE</sub> = 4 V, I <sub>C</sub> = 4 A V <sub>CE</sub> = 4 V, I <sub>C</sub> = 8 A	1000 100	12K	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage <sup>(1)</sup>	$I_C = 4 \text{ A}, I_B = 16 \text{ mA}$ $I_C = 8 \text{ A}, I_B = 80 \text{ mA}$		2 4	V V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage <sup>(1)</sup>	$I_C = 8 \text{ A}, I_B = 80 \text{ mA}$		4.5	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage <sup>(1)</sup>	$V_{CE} = 4 \text{ V}, I_{C} = 4 \text{ A}$		2.8	V
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0 f= 0.1MHz		200	pF

#### Note:

1. Pulse test: pw  $\leq 300~\mu s,~duty~cycle \leq 2\%.$ 

#### **Typical Performance Characteristics**

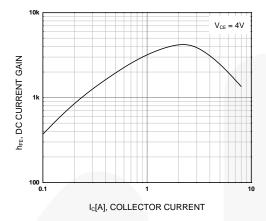


Figure 1. DC current Gain

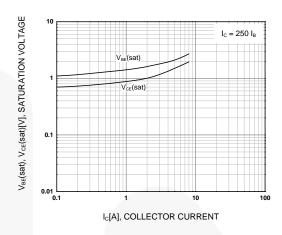


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

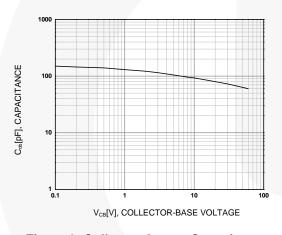


Figure 3. Collector Output Capacitance

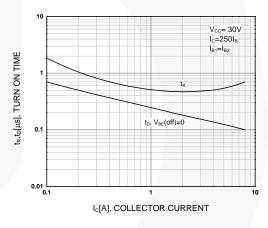


Figure 4. Turn On Time

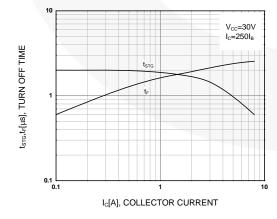


Figure 5. Turn Off Time

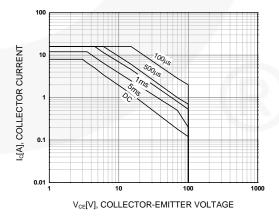


Figure 6. Safe Operating Area

### **Typical Performance Characteristics** (Continued)

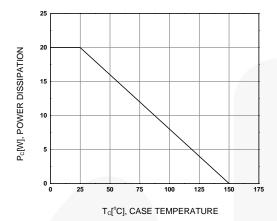
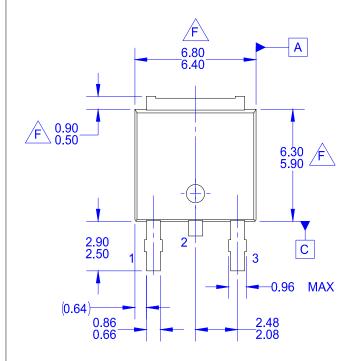
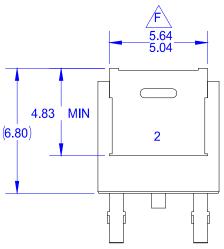


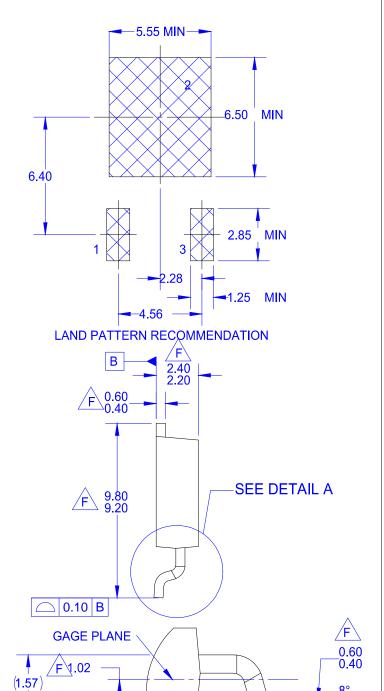
Figure 7. Power Derating Curve





#### NOTES:UNLESS OTHERWISE SPECIFIED

- A) NOT COMPLIANT TO JEDEC TO-252 VARIATION AB
- ALL DIMENSION ARE IN MILLIMETER
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- LAD PATTERN PER IPC7351A ATANDARD TO228P991X239-3N
- DRAWING FILE NAME:MKT-TO252D03REV4.
- F) DOES NOT COMPLY JEDEC STANDARD VALUE.
  G) FAIRCHILD SEMICONDUCTOR.



**DETAIL A** 

**SCALE 10:1** 

**SEATING PLANE** 

ŏ°

FAIRCHILD.

MÍN

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative